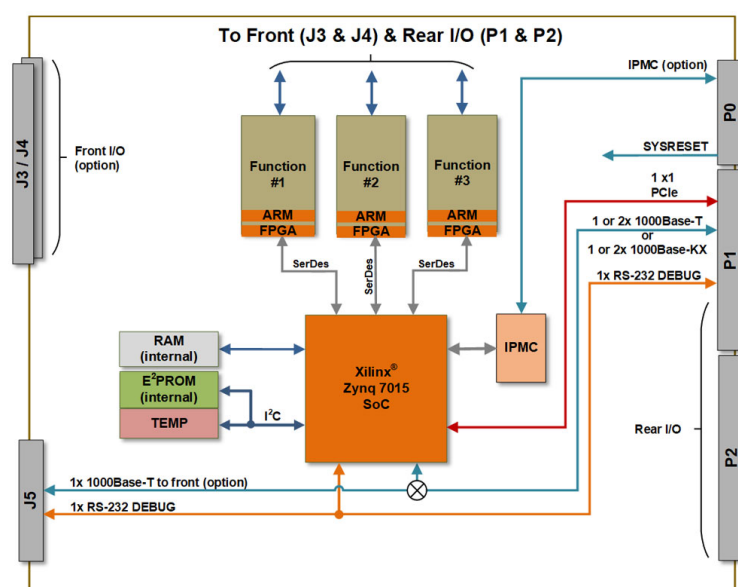




68G5 3U OpenVPX Multifunction I/O Boards

3U OpenVPX Multifunction I/O Board

The 68G5 is NAI's latest rugged 3U OpenVPX multifunction I/O and communications board. It provides high-performance I/O capabilities specifically designed for demanding aerospace, defense, and industrial applications. The board can accommodate up to three NAI Configurable Open Systems Architecture™ (COSA®) smart function modules. By configuring the 68G5 with these modules, engineers and systems architects can customize the board's functional capabilities to suit their specific application requirements and accelerate the deployment of SWaP-C optimized systems.



Features

- **3U OpenVPX**
- **Profiles Supported:**
 - Module profile: MOD3-PER-1U-16.3.3-2
 - Slot profile: SLT3-PER-1U-14.3.3
- **Front and/or rear I/O**
- **PCIe (x1)**
- **Supports Three NAI smart I/O function modules**
 - COSA® architecture
 - 100+ modules to choose from
 - Independent x1 SerDes interface to each function module slot
- **2x 10/100/1000 Base-T or 1000Base-KX Ethernet; 2 to rear or 1 to rear and 1 to front I/O**
- **Intelligent I/O library support included**
- **Background Built-in-Test Continuous (BIT)**
- **VICTORY Interface Services (Contact factory)**
- **Operating Temperature**
 - Commercial: 0°C to 70°C
 - Rugged: -40°C to 85°C

Select up to 3 independent functions for your application

| I/O Modules | | | | | |
|---|---------------------|---|--|---------------------|--|
| Function | Module | Description | Function | Module | Description |
| Analog-to-Digital | AD1 | 12 CH. A/D, ± 10 V, Dedicated, 256 kHz (max), Sigma-Delta | Digital-to-Analog | DA5 | 4 CH. D/A. High-Voltage/High-Current Half-Bridge (2 Channels Full-Bridge) External VCC Sourced Outputs |
| | AD2 | 12 CH. A/D, ± 100 V (max), Dedicated, 256 kHz (max), Sigma-Delta | Digital IO - Differential Transceiver | DF1 | 16 CH. Differential I/O, Input: -10 V to +10 V (422), -7 V to +12 V (485) Output: -25 V to +5 V |
| | AD3 | 12 CH. A/D, ± 25 mA, Dedicated, 256 kHz (max), Sigma-Delta | | DF2 | 16 CH. 16 Channel Enhanced Differential I/O |
| | AD4 | 16 CH. A/D, ± 10 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR | Discrete IO - Multichannel, Programmable | DT1 | 24 CH. Discrete I/O, 0-60 VDC Input/Output, Max Iout 500 mA - 2 A, Source/Sink (out) |
| | AD5 | 16 CH. A/D, ± 50 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR | | DT2 | 16 CH. Discrete I/O, ± 80 V Input/Output, Max Iout 600 mA, Isolated/Ch Switch (out) |
| | AD6 | 16 CH. A/D, ± 100 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR | | DT3 | 4 CH. DT Switch Output @ 65V/2A (max), Isolated/Ch, External VCC/VSS (paired) |
| | ADE | 16 CH. A/D, ± 10 V, Individual 16-bit SAR, 200 kHz max., Simultaneous Sampling | | DT4 | 24 CH. Enhanced DT1 |
| | ADF | 16 CH. A/D, ± 100 V, Individual 16-bit SAR, 200 kHz max., Simultaneous Sampling | | DT5 | 16 CH. Enhanced DT2 |
| | ADG | 16 CH. A/D, ± 25 mA, Individual 16-bit SAR, 200 kHz max., Simultaneous Sampling | Relay | RY1 | 4 CH. Relay, 220V/2A @ 60W/62.5VA (Max), Non Latching |
| Chip Detector and Fuzz Burn | CD1 | 6 CH. Chip Detector (CD) and Fuzz Burn (FB) | | RY2 | 4 CH. Relay, 220V/2A @ 60W/62.5VA (Max), Latching |
| Digital-to-Analog | DA1 | 12 CH. D/A, ± 10 V, 25 mA Per Channel, Current or Voltage Control | Digital IO - TTL, CMOS | TL1 | 24 CH. TTL I/O, Standard Functionality, Programmable |
| | DA2 | 16 CH. D/A, ± 10 V, 10 mA Per Channel, No Current Control | | TL2 | 24 CH. TTL I/O, Enhanced Functionality, Programmable |
| | DA3 | 4 CH. D/A, ± 40 V, ± 100 mA, Voltage or Current Output | Variable Reluctance | VR1 | 8 CH. Variable Reluctance Signal Input and General-Purpose Pulse Counter, ± 100 V, 100 kHz (max) |
| | DA4 | 4 CH. D/A, ± 20 to ± 80 , 10 mA, Voltage Control Only | | | |
| Measurement & Simulation Modules | | | | | |
| Function | Module | Description | Function | Module | Description |
| AC Reference | AC2 | 2 CH. AC Reference Source, 47 Hz - 20 KHz, $\pm 3\%$ Acc, 2 - 28 Vrms, 6 VA (Max/Ch) Power | LVDT RVDT Measurement and Simulation | LD5 | 4 CH. LVDT/RVDT to Digital, 28-90 Vrms Input, 2-115 Vrms Exc, 47 Hz - 1 KHz Freq |
| | AC3 | 2 CH. AC Reference Source, 47 Hz - 2.5 KHz, $\pm 3\%$ Acc, 28 - 115 Vrms, 6 VA (Max/Ch) Power | IRIG Timecode Receiver and Generator | RG1 | 1 CH. IRIG Timing Function Interface |
| Synchro Resolver Measurement and Simulation | DSK | 3 CH. Digital to Synchro, 2-28 VLL, 2-115 Vrms Exc, 1 KHz - 5 KHz Freq, .5 VA/Ch (Max) | Thermocouple and RTD Measurement | RT1 | 8 CH. Resistance Temperature Detectors (RTD), 2, 3, or 4 wire, 16 Bit Res, 16.7 Hz/Ch |
| LVDT RVDT Measurement and Simulation | LD1 | 4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 47 Hz - 1 KHz Freq | | TC1 | 8 CH. Thermocouple, 4.17 - 470 Hz, ± 100 mV A/D |
| | LD2 | 4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 1 KHz - 5 KHz Freq | | TR1 | 8 CH. Thermocouple (TCx) & Resistance Temperature Detectors (RTD), programmable per channel |
| | LD3 | 4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 5 KHz - 10 KHz Freq | Strain Gauge Measurement | SG1 | 4 CH. Strain Gauge, 4.7 Hz - 4.8 KHz, Measurement, Conventional 4-Arm Bridge |
| | LD4 | 4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 10 KHz - 20 KHz Freq | | | |

| Communication Modules | | | | | |
|-----------------------|------------|--|-----------------------|------------|--|
| Function | Module | Description | Function | Module | Description |
| ARINC Communications | <u>AR1</u> | 12 CH. ARINC 429, 100 KHz or 12.5 KHz, RX/TX, 256 Word Tx/Rx Buffer | MIL-STD-1553B | <u>FTE</u> | 2 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Direct Coupled |
| | <u>AR2</u> | 1 CH. ARINC 568 (CH-1, RX & TX) & 1 Channel ARINC 579 (CH-2, Programmable RX or TX), 1024-Word TX & RX Buffers per Ch. | | <u>FTF</u> | 4 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Direct Coupled |
| CANBus Communications | <u>CB1</u> | 8 CH. CANBus, CAN 2.0 A/B, 16 K RX/TX Buffer, 1 Mb/s Max Data Rate | MIL-STD-1760 | <u>FTJ</u> | 1 CH. MIL-STD-1760 (1553), BC, RT, BM, BM/RT, 128 KB RAM, Transformer Coupled |
| | <u>CB2</u> | 8 CH. CANBus, J1939, 16 K RX/TX Buffer, 500 kb/s Max Data Rate | | <u>FTK</u> | 2 CH. MIL-STD-1760 (1553), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled |
| | <u>CB3</u> | 8 CH. CANBus, CAN 2.0 A/B (CB1) or J1939 (CB2) protocol layer programmable per channel | Serial Communications | <u>SC1</u> | 4 CH. Serial, RS-232/422/423 (MIL-STD-188C)/485, Non Isolated |
| MIL-STD-1553B | <u>FTA</u> | 1 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM, Transformer Coupled | | <u>SC3</u> | 8 CH. (max) RS-232/422/485 Serial Communications or GPIO, Programmable, Non-isolated |
| | <u>FTB</u> | 2 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled | | <u>SC5</u> | 4 CH. RS-232/422/485 communications, isolated per channel and from SYS GND |
| | <u>FTC</u> | 4 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled | | <u>SC6</u> | 4 CH. RS-232/422/485 communications, individual SYS GND provided per channel (non-isolated) |
| | <u>FTD</u> | 1 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM, Direct Coupled | | | |
| Combination Modules | | | | | |
| Function | Module | Description | Function | Module | Description |
| Combo | <u>CM5</u> | 2 CH. Dual-redundant MIL-STD-1553 & 8 Channel ARINC 429/575, 100 KHz or 12.5 KHz, RX or TX, 256 Word Tx/Rx Buffer | Combo | <u>CM8</u> | 2 CH. Dual-redundant MIL-STD-1553 & 12 Channel Discrete I/O, 0-60 VDC Input/Output, Max Iout 500 mA - 2 A, Source/Sink (out) |

Architected for Versatility

NAI's Configurable Open Systems Architecture™ (COSA®) offers a choice of over 100 smart I/O, communications, or Ethernet switch functions, providing the highest packaging density and greatest flexibility of ruggedized embedded product solutions in the industry. Preexisting, fully-tested functions can be combined in an unlimited number of ways quickly and easily.

One-Source Efficiencies

Eliminate man-months of integration with a configured, field-proven system from NAI. Specification to deployment is a seamless experience as all design, state-of-the-art manufacturing, assembly and test are performed - by one trusted source. All facilities are located within the U.S. and optimized for high-mix/low volume production runs and extended lifecycle support.

Product Lifecycle Management

From design to production and beyond, NAI's product lifecycle management strategy ensures the long-term availability of COTS products through configuration management, technology refresh and obsolescence component purchase and storage.

All specifications are subject to change without notice. All product and company names are trademarks or registered trademarks of their respective holders

